

# Technical Data Sheet

	Froduct Name: P	LCC2 2810 215 High Bright Green Li	ŁD
	Part Number:	RD2810-121UGC	
	Customer:		
	<b>Customer PN:</b>		
	Version:	A.2	
	Date:	May 13, 2015	
	Custon	ner Approval	
Instituted By:	Checked	By: Approved By:	
_		o Optoelectronics Co., Ltd.	

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Rig	Doo To	echnical	Data Sl	neet	
	Part No.:	RD2810-1	21UGC		
Version	A.2	Issued date	May 13, 2015	Page	1 of 12

#### 1. Features

• Package ( L/W/H ) : 2.8\*1.0\*1.2mm

• Color: Ultra High Bright Green

• Lens: Water Clear Flat Mold

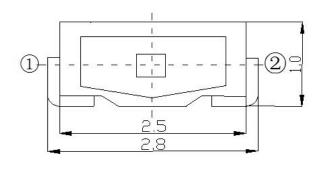
EIA STD Package

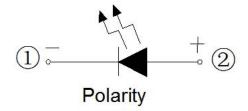
• Meet ROHS, Green Product

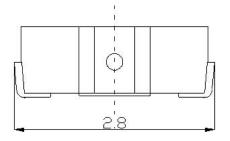
Compatible With SMT Automatic Equipment

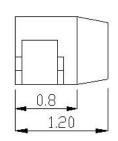
Compatible With Infrared Reflow Solder Process

## 2. Package Profile & Soldering PAD Suggested

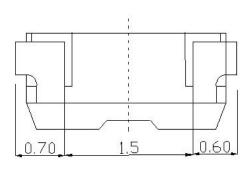


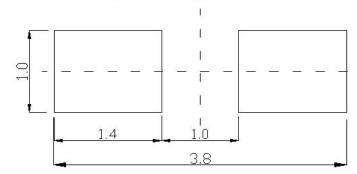






#### Soldering PAD Suggested:





Notes: a. All dimensions are in millimeters;

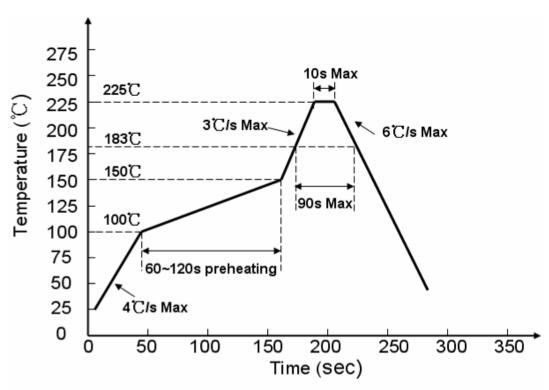
b. Tolerance is  $\pm 0.10$  mm unless otherwise noted.



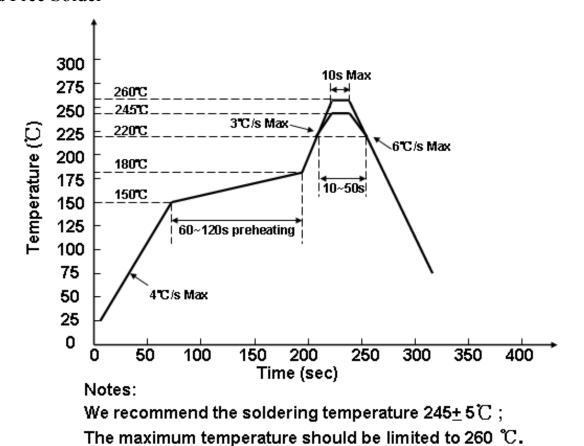
Rig	Doo T	echnical	Data Sh	eet	
Part No.: RD2810-121UGC					
Version	A.2	Issued date	May 13, 2015	Page	2 of 12

## 3. Soldering Profile Suggested

For Lead Solder



For Lead Free Solder





Rig	gDoo '	Technical	Data Sh	eet	
Part No.: RD2810-121UGC					
Version	A.2	Issued date	May 13, 2015	Page	3 of 12

## **4. Absolute Maximum Ratings At Ta=25℃**

Parameter	Symbol	Rating	Unit	
Power Dissipation	Pd	90	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	70	mA	
DC Forward Current	IF	30	mA	
Reverse Voltage	VR	5	V	
Operating Temperature Range	Topr	-30°C ~ +85°C		
Storage Temperature Range	Tstg	-40°C ~ +90°C		
Soldering Condition	Tsol	Reflow soldering: 260°C For 5 Seconds Hand soldering: 300°C For 3 Seconds		
ESD CLASS	ESD	2000	V	



# RigDoo Technical Data Sheet Part No.: RD2810-121UGC

May 13, 2015

Page

4 of 12

Issued date

5. Electrical Optical Characteristics At Ta=25℃

A.2

Version

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV		-1400-		mcd	IF = 20mA
Viewing Angle	201/2		120		deg	IF = 20mA
Peak Wavelength	λd		530		nm	IF=20mA
Dominant Wavelength	λр	515-		524-	nm	IF=20mA
Spectral Line Half-Width	Δλ		30		nm	IF=20mA
Forward Voltage	VF	2.8		3.6	V	IF=20mA
Reverse Current	IR			5	uA	VR=5V

- Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
  - 2.  $\theta$ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
  - 3. The dominant wavelength,  $\lambda d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



Rig	Doo Te	chnical	Data Sh	eet		
	Part No.: RD2810-121UGC					
Version	A.2	Issued date	May 13, 2015	Page	5 of 12	

## 6. General Characteristics

#### 1、IV

Bin	Min	Max	Unit	Condition
R1	1150	1400		
R2	1400	1800	MCD	IF=20mA
S1	1800	2300		

#### 2, VF

Bin	Min	Max	Unit	Condition
6	2.8	3.0		
7	3.0	3.2		
8	3.2	3.4	V	IF=20mA
9	3.4	3.6		

Notes: Tolerance of Forward Voltage:  $\pm 0.02V$ 

### 3、WLD

Bin	Min	Max	Unit	Condition
В	515	518		
С	518	521	nm	IF=20mA
D	521	524		



RigDoo	Technical	Data	Sheet	
D4 N	I. DD3010	111TCC		

**Part No.: RD2810-121UGC** 

Version A.2 Issued date

May 13, 2015

Page

6 of 12

## 7. Typical Electrical-Optical Characteristics Curves

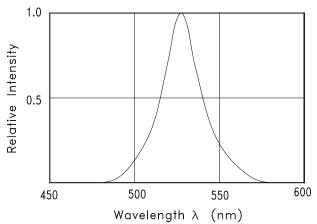
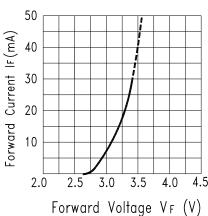


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH



Forward Voltage VF (V)
Fig.2 Forward Current vs.
Forward Voltage

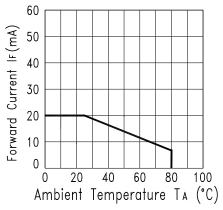


Fig.3 Forward Current Derating Curve

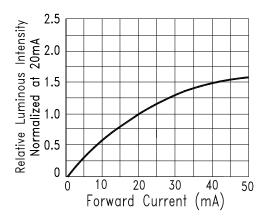


Fig.4 Relative Luminous Intensity vs. Forward Current

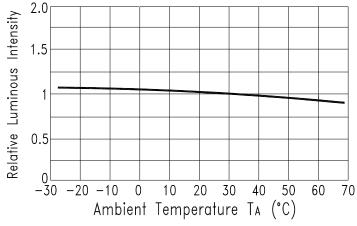


Fig.5 Luminous Intensity vs.Ambient Temperature

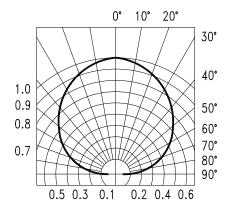


Fig.6 Spatial Distribution



RigDoo	Technical	Data	Sheet	
Part N	No.: RD2810-	121UGC		

## Version A.2 Issued date May 13, 2015

## 8. Label Explanation

CAT: Luminous Intensity Rank (unit: mcd)

HUE: CIE 1931 Coordinate Rank

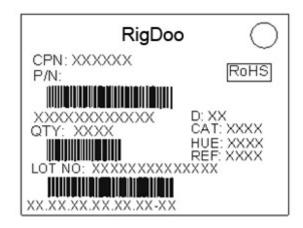
REF: Forward Voltage Rank (unit: V)

Rank Tolerance:

a. Luminous Intensity: ± 11%

b. HUE: ±0.005

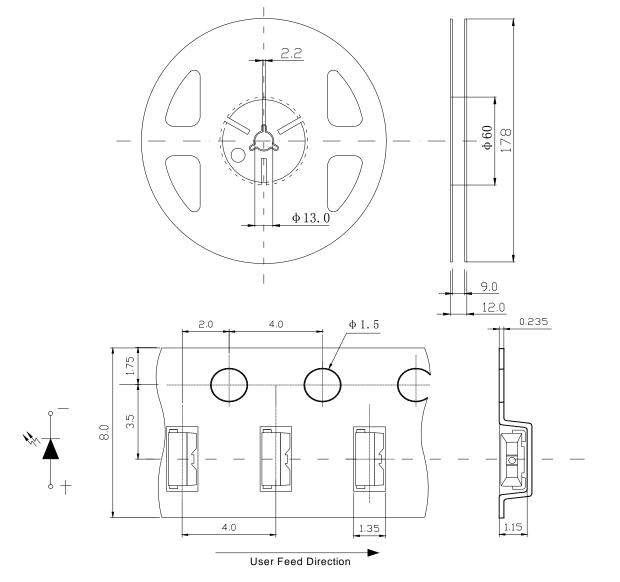
c. Forward Voltage:  $\pm 0.02V$ 



Page

7 of 12

### 9. Reel And Tape Dimensions:



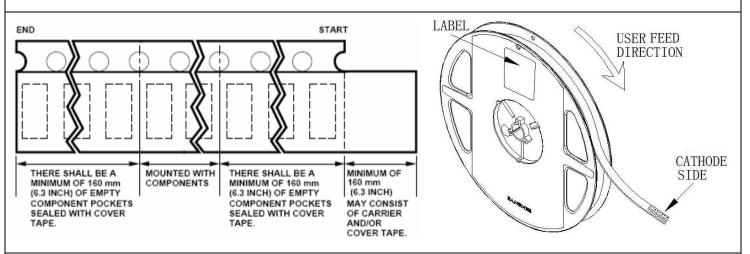
Notes: 1. All dimensions are in millimeters;

2. Tolerance is  $\pm$  0.1 mm unless otherwise noted.

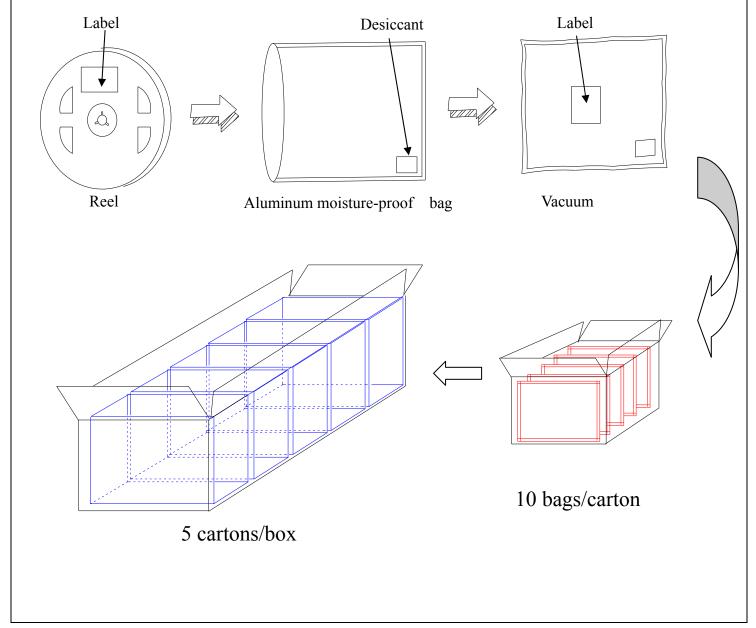


RigDoo Technical Data Sheet						
Part No.: RD2810-121UGC						
Version	A.2	Issued date	May 13, 2015	Page	8 of 12	

## 10. Tape Leader & Trailer Dimensions And Reel



### 11. Packaging:





## RigDoo Technical Data Sheet

**Part No.: RD2810-121UGC** 

Version A.2 Issued date May 13, 2015 Page 9 of 12

## 12. Reliability Test

Classification	Test Item	Test Condition	Reference Standard	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS,+72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5°C,RH= 85%	1000HRS±2HRS	JESD22-A101
	High Temperature Storage	Ta= 105±5°C	1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C	1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
Environmental Test	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}\mathbb{C} \sim -40^{\circ}\mathbb{C} \pm 5^{\circ}\mathbb{C}$ 10mins 10mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T.sol= 260 ± 5°C	$10 \pm 1 \mathrm{secs}$	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
	IR-Reflow Normal Process	Ramp-up rate(183°C to Peak) +3°C/ second max  Temp. maintain at 125(±25)°C 120 seconds max  Temp. maintain above 183°C 60-150 seconds  Peak temperature range 235°C+5/-0°C  Time within 5°C of actual Peak Temperature (tp)  10-30 seconds  Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max  Temp. maintain at 175(±25)°C 180 seconds max  Temp. maintain above 217°C 60-150 seconds  Peak temperature range 260°C+0/-5°C  Time within 5°C of actual Peak Temperature (tp)  20-40 seconds  Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	Solderability	T.sol= $235 \pm 5$ °C Immersion rate $25\pm2.5$ mm/sec Coverage $\geq 95\%$ of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

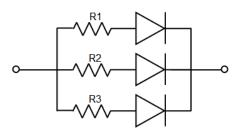


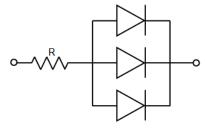
Rig	Doo To	echnical	Data Sl	neet		
Part No.: RD2810-121UGC						
Version	A.2	Issued date	May 13, 2015	Page	10 of 12	

#### 12. Cautions

#### Application

- 1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
- 2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.





Circuit model A

Circuit model B

3. High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

#### **Storage**

- 1.Before opening original package, it is recommended to store them in the following environment: Temperature:  $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ ; Humidity: 85%RH max. When the inventory over 2months,Should be done before treatment using dehumidification, Temperature:  $60^{\circ}\text{C}/8$  hours.
- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 48hrs (2 days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 48hrs (2 days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

#### **ESD** (Electrostatic Discharge )-Protection

A LED (especially the Blue. White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc. Some advice as below should be noticed:

1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.



Rig	Doo	Technical	Data S	Sheet		
Part No.: RD2810-121UGC						
Version	A.2	Issued date	May 13, 2015	5 Page	11 of 12	

- 2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded (Grounding impedance value within  $10\Omega$ ) .
  - 3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
  - 4. Use ionizer to neutralize the static charge during handling or operating.
  - 5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

#### Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

#### **Soldering**

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 1.
- 2. Reflow soldering should not be done more than 2 times.
- 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

#### **Others**

- 1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult RigDoo's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
- 2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
- 3. The appearance and specifications of the product may be modified for improvement without prior notice.
- 4. LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating